

Photo Modules for PCM Remote Control Systems

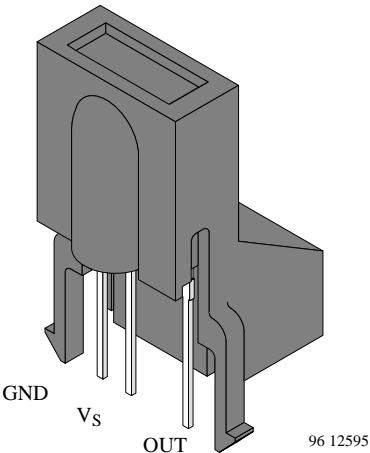
Available types for different carrier frequencies

Type	fo	Type	fo
TSOP1130XG1	30 kHz	TSOP1133XG1	33 kHz
TSOP1136XG1	36 kHz	TSOP1137XG1	36.7 kHz
TSOP1138XG1	38 kHz	TSOP1140XG1	40 kHz
TSOP1156XG1	56 kHz		

Description

The TSOP11..XG1 – series are miniaturized receivers for infrared remote control systems. PIN diode and preamplifier are assembled on lead frame, the epoxy package is designed as IR filter.

The demodulated output signal can directly be decoded by a microprocessor. The main benefit is the operation with short burst transmission codes (e.g. RECS 80) and high data rates.



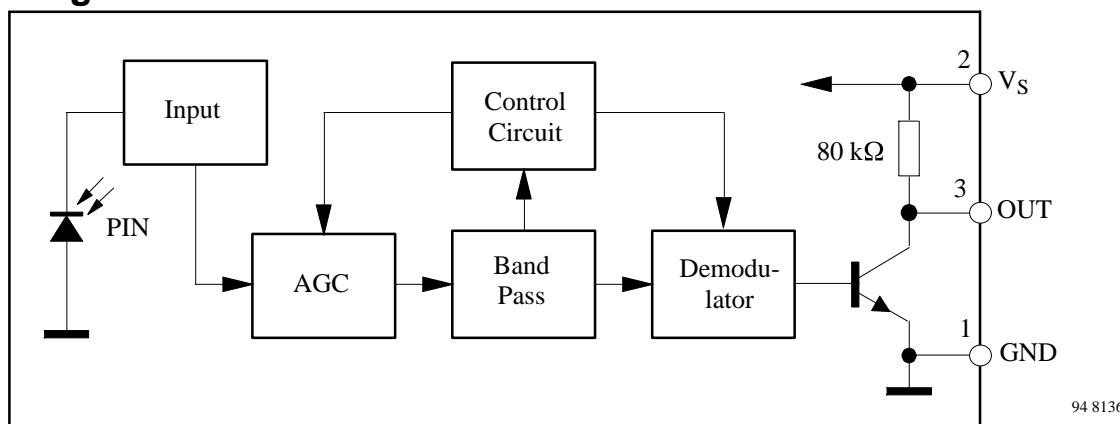
Features

- Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Improved shielding against electrical field disturbance
- TTL and CMOS compatibility
- Output active low
- Low power consumption
- High immunity against ambient light

Special Features

- Enhanced data rate of 2400 bit/s
- Operation with short bursts possible (≥ 6 cycles/burst)

Block Diagram



Absolute Maximum Ratings

$T_{amb} = 25^\circ C$

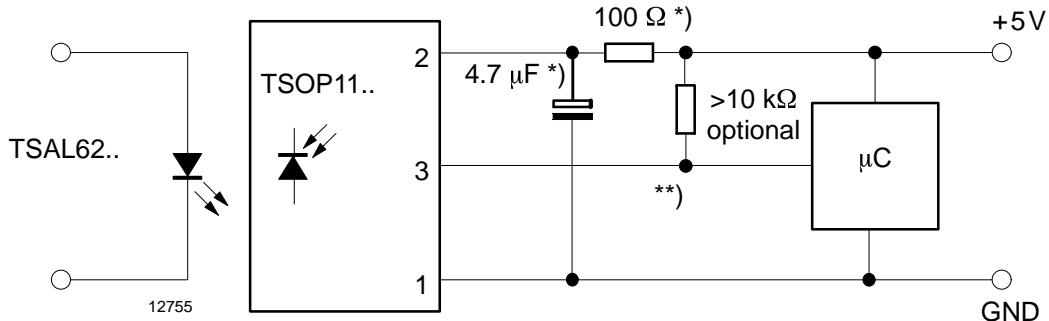
Parameter	Test Conditions	Symbol	Value	Unit
Supply Voltage	(Pin 2)	V_S	-0.3...6.0	V
Supply Current	(Pin 2)	I_S	5	mA
Output Voltage	(Pin 3)	V_O	-0.3...6.0	V
Output Current	(Pin 3)	I_O	5	mA
Junction Temperature		T_j	100	$^\circ C$
Storage Temperature Range		T_{stg}	-25...+85	$^\circ C$
Operating Temperature Range		T_{amb}	-25...+85	$^\circ C$
Power Consumption	($T_{amb} \leq 85^\circ C$)	P_{tot}	50	mW
Soldering Temperature	$t \leq 5$ s	T_{sd}	260	$^\circ C$

Basic Characteristics

$T_{amb} = 25^\circ C$

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Supply Current (Pin 2)	$V_S = 5$ V, $E_v = 0$	I_{SD}	0.4	0.6	1.5	mA
	$V_S = 5$ V, $E_v = 40$ klx, sunlight	I_{SH}		1		mA
Supply Voltage (Pin 2)		V_S	4.5		5.5	V
Transmission Distance	$E_v = 0$, test signal see fig.8, IR diode TSAL6200, $I_F = 0.4$ A	d		35		m
Output Voltage Low (Pin 3)	$I_{OSL} = 0.5$ mA, $E_e = 0.7$ mW/m ² , $f = f_0$, test signal see fig.7	V_{OSL}			250	mV
Irradiance (30 – 40 kHz)	Test signal see fig.7	E_e min		0.4	0.6	mW/m ²
	Test signal see fig.8			0.35	0.5	
Irradiance (56 kHz)	Test signal see fig.7	E_e min		0.45	0.7	
	Test signal see fig.8			0.40	0.6	
Irradiance	Test signal see fig.7	E_e max	30			W/m ²
Directivity	Angle of half transmission distance	$\phi_{1/2}$		± 45		deg

Application Circuit



*) recommended to suppress power supply disturbances

**) The output voltage should not be held continuously at a voltage below 3.3V by the external circuit.

Suitable Data Format

The circuit of the TSOP11..XG1 is designed in that way that unexpected output pulses due to noise or disturbance signals are avoided. A bandpassfilter, an integrator stage and an automatic gain control are used to suppress such disturbances.

The distinguishing mark between data signal and disturbance signal are carrier frequency, burst length and duty cycle.

The data signal should fullfill the following condition:

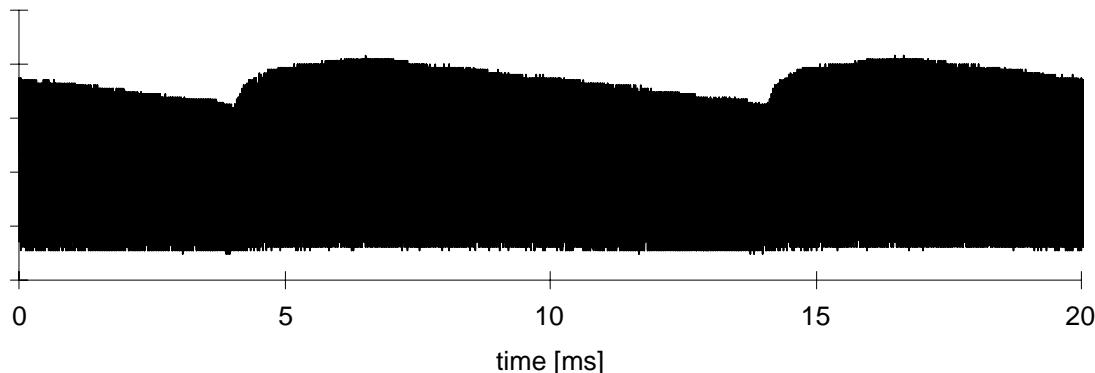
- Carrier frequency should be close to center frequency of the bandpass (e.g. 38kHz).
- Burst length should be 6 cycles/burst or longer.
- After each burst which is between 6 cycles and 70 cycles a gap time of at least 10 cycles is necessary.
- For each burst which is longer than 1.8ms a corresponding gap time is necessary at some time in the data stream. This gap time should have at least same length as the burst.
- Up to 2200 short bursts per second can be received continuously.

Some examples for suitable data format are: NEC Code, Toshiba Micom Format, Sharp Code, RC5 Code, RC6 Code, RCMM Code, R-2000 Code, RECS-80 Code.

When a disturbance signal is applied to the TSOP11..XG1 it can still receive the data signal. However the sensitivity is reduced to that level that no unexpected pulses will occure.

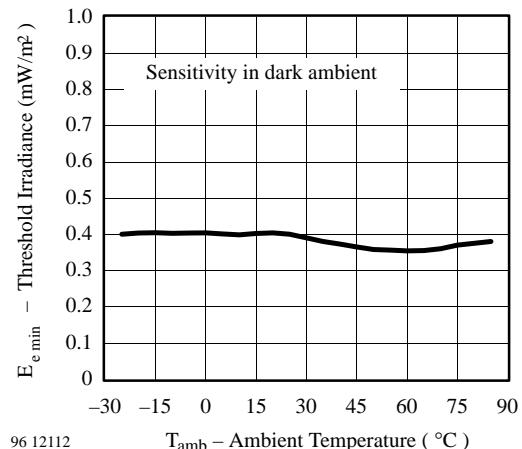
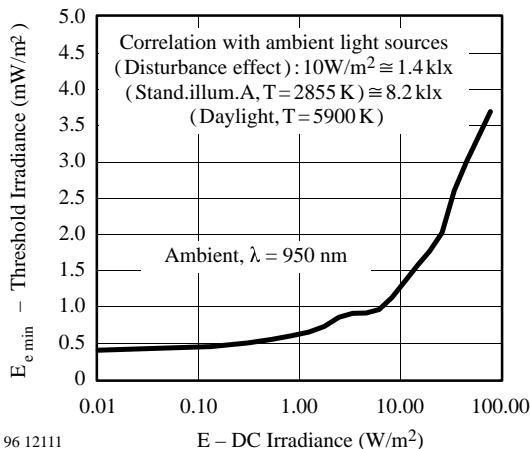
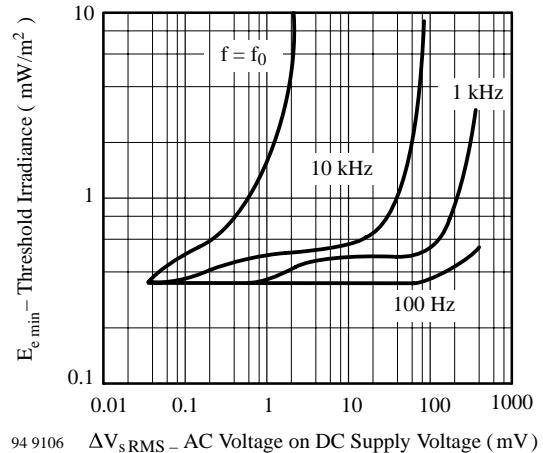
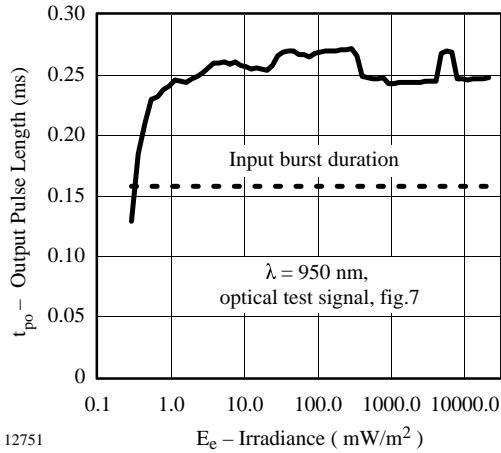
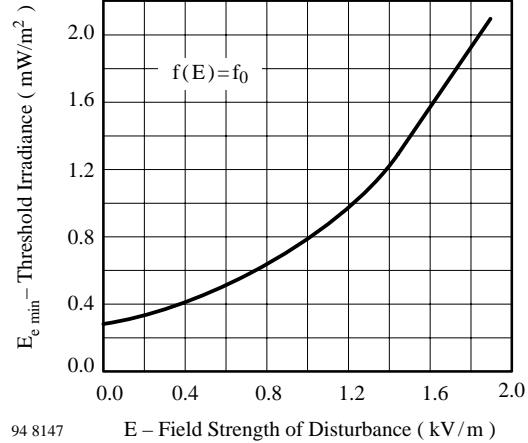
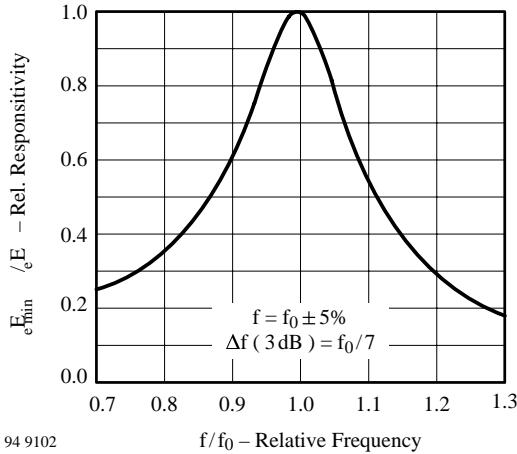
Some examples for such disturbance signals which are suppressed by the TSOP11..XG1 are:

- DC light (e.g. from tungsten bulb or sunlight)
- Continuous signal at 38kHz or at any other frequency
- Signals from fluorescent lamps with electronic ballast (an example of the signal modulation is in the figure below).



IR Signal from Fluorescent Lamp with low Modulation

Typical Characteristics ($T_{amb} = 25^{\circ}C$ unless otherwise specified)



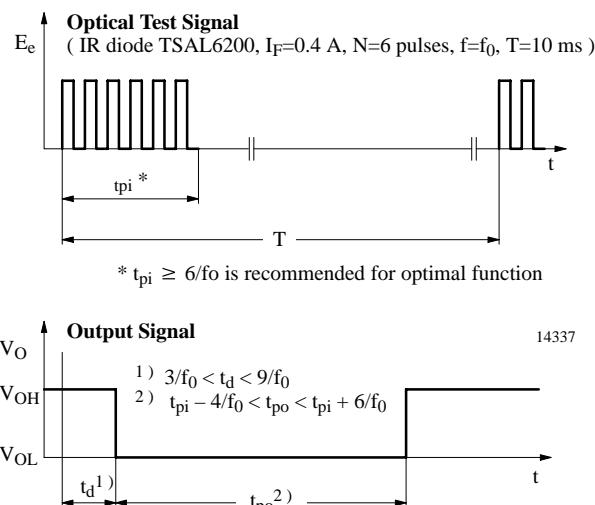


Figure 7. Output Function

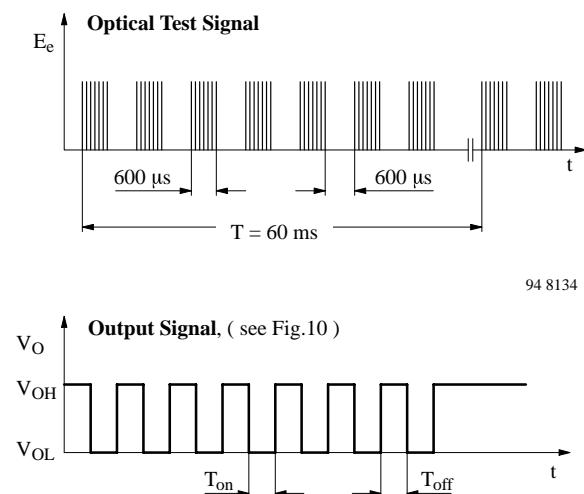


Figure 8. Output Function

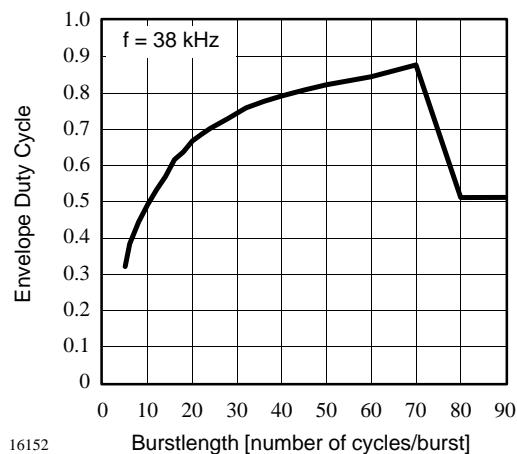


Figure 9. Max. Envelope Duty Cycle vs. Burstlength

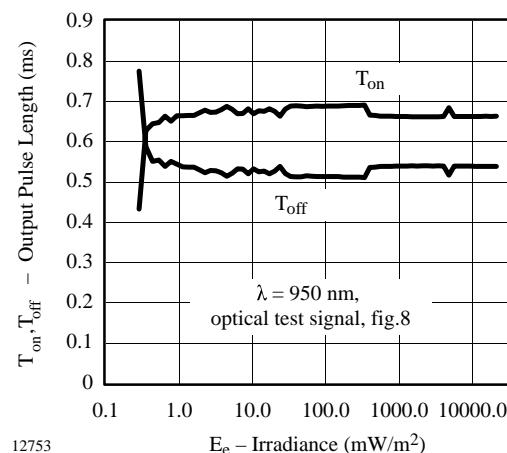


Figure 10. Output Pulse Diagram

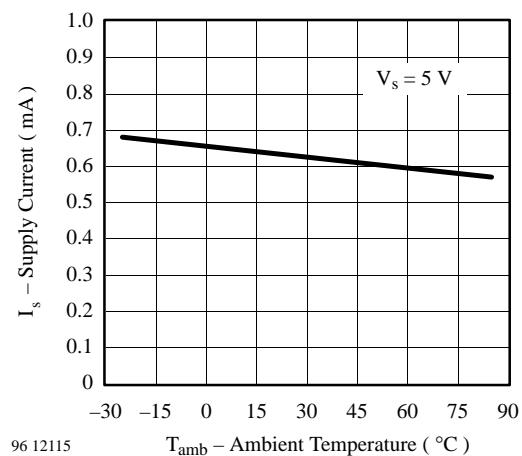


Figure 11. Supply Current vs. Ambient Temperature

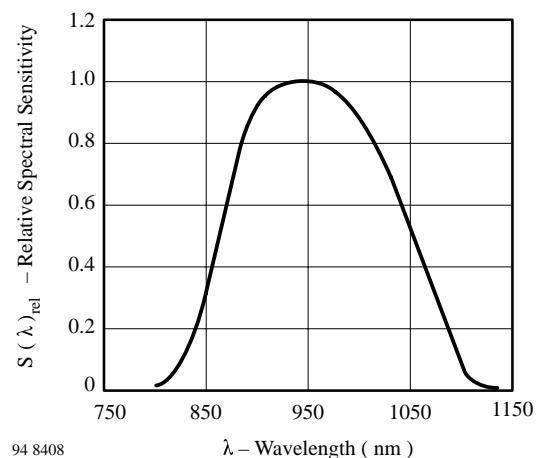


Figure 12. Relative Spectral Sensitivity vs. Wavelength

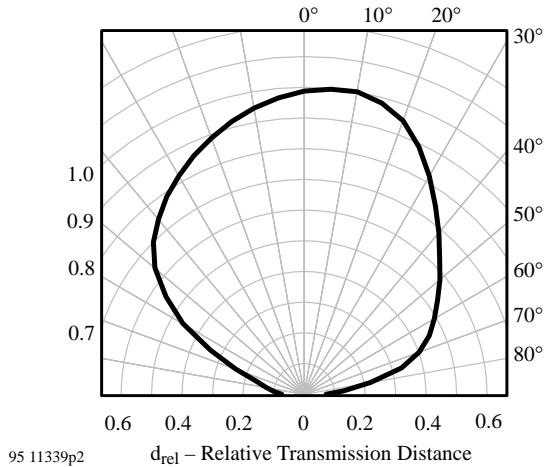


Figure 13. Vertical Directivity ϕ_y

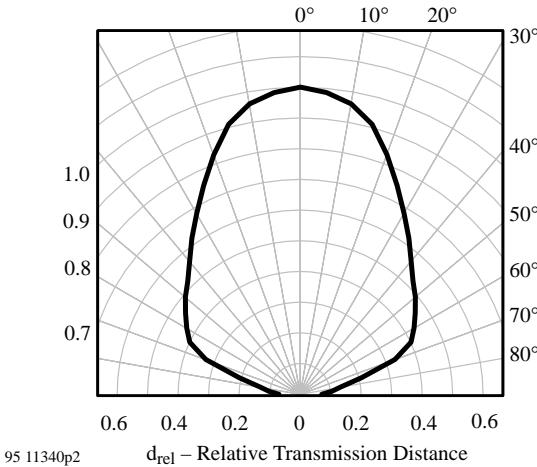
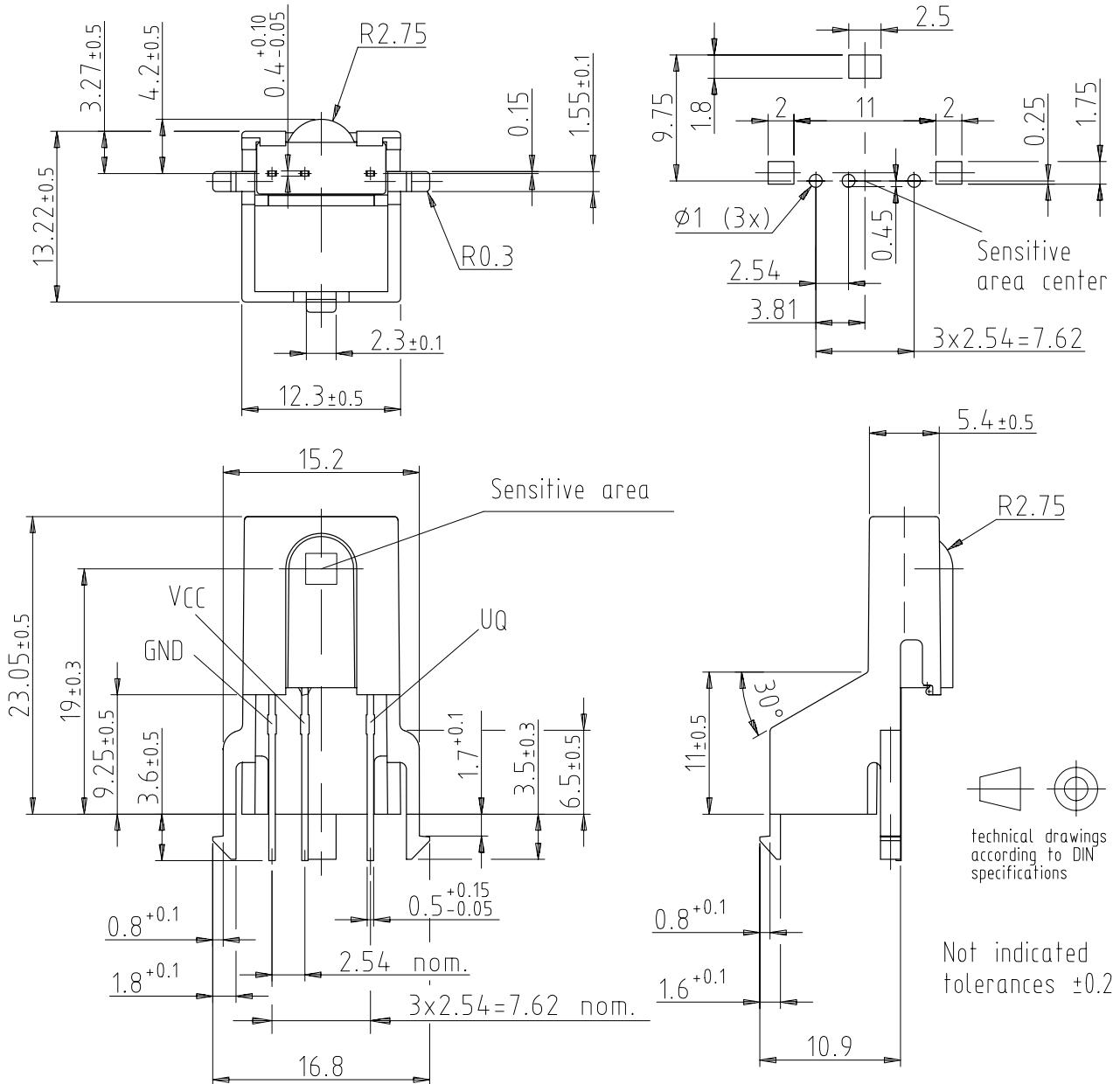


Figure 14. Horizontal Directivity ϕ_x

Dimensions in mm

Recommended TEMIC installation dimension diagram
Mount.-side



Drawing refers to following types: TFMX 5... TFMX 5... SN

TSOP 11..XG.

TSOP 12..XG.

TSOP 13..XG.

TSOP 15..XG.

TSOP 17..XG.

TSOP 92..XG.

TSOP11..XG1

Vishay Telefunken



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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